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8-Channel 7-Level $\pm 80V$ High-Voltage Pulsar with T/R Switches

Features

- High-Voltage CMOS Technology for High Performance
- 8-Channel, True 5-Level or Pseudo 7-Level, $\pm 80V$, 2A, with Return-to-Zero (RTZ) to True Zero Voltage
- Programmable $\pm 0.5A$, 1.0A, 1.5A and 2A Output Current from V_{PP1}/V_{NN1}
- Integrated Radio Frequency (RF) Blocking, Clamp Diode and RX Damp
- 13 Ω Transmit/Receive (T/R) and Low Voltage (LV) Switches Allow Receiver Multiplexing
- 160 Ω Auto-Bleeding Switches for RTZ True Zero
- 220 MHz Clock Retiming Synchronization Capability
- 2.5V, 3.3V Logic Control Voltage, designed to work with FPGA Inputs and Outputs (I/O) directly.
- Adjusting T/R Switch Delay, Avoid Echo Saturating
- TX Output Frequency up to 20 MHz
- -40 dB HD2 Second Harmonic Distortion at 5 MHz
- 12 mm x 12 mm x 1.20 mm 206-Lead TFBGA Package

Applications

- Medical ultrasound imaging system
- NDT (nondestructive testing) ultrasound transmission pulsers
- Piezoelectric or capacitive transducer drivers

Description

The HV7322 device is an 8-channel, true 5-level or pseudo 7-level, high-voltage pulser, with integrated T/R switches. HV7322 is designed for medical ultrasound applications. It is also fitted for NDT and other transducer drive applications.

The HV7322 device's output has seven different voltage levels: $V_{PP0,1,2}$, $V_{NN0,1,2}$ and GND. The output MOSFET transistors can provide up to $\pm 2A$ of current at the maximum voltage of $\pm 80V$. HV7322 has channel RTZ for the return-to-zero feature. The three sets of high-voltage outputs, with $\pm 2A$ of peak output current in B-Mode and programmable 2-bit, use the V_{PP1}/V_{NN1} voltage rails for the CW-Mode ($IM<1:0> = 0$), in order to reduce the CW-Mode power dissipations on chip.

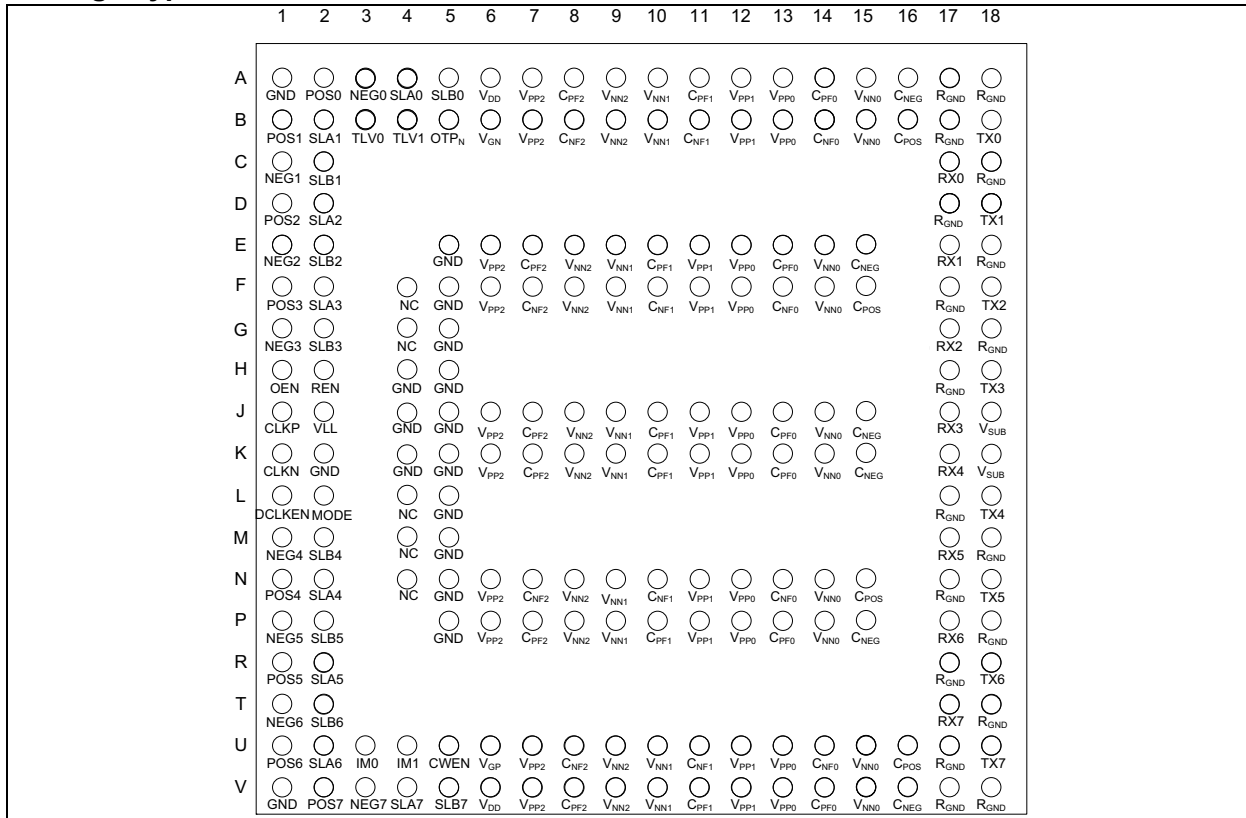
The high-voltage T/R and LV analog switches (total 13 Ω) and RX damp switch are integrated in each channel, while the 160 Ω RTZ switches dedicated for true zero voltage minimize the received noise.

The 220 MHz differential retiming clock inputs and built-in registers are capable of providing low jitter in Continuous Wave Doppler (CWD) mode, in Pulse Wave (PW) mode or in B-mode. The clock synchronization realigns the logic input signals to a master clock, which reduces various propagation delays caused by FPGA inaccuracies and/or long PCB traces.

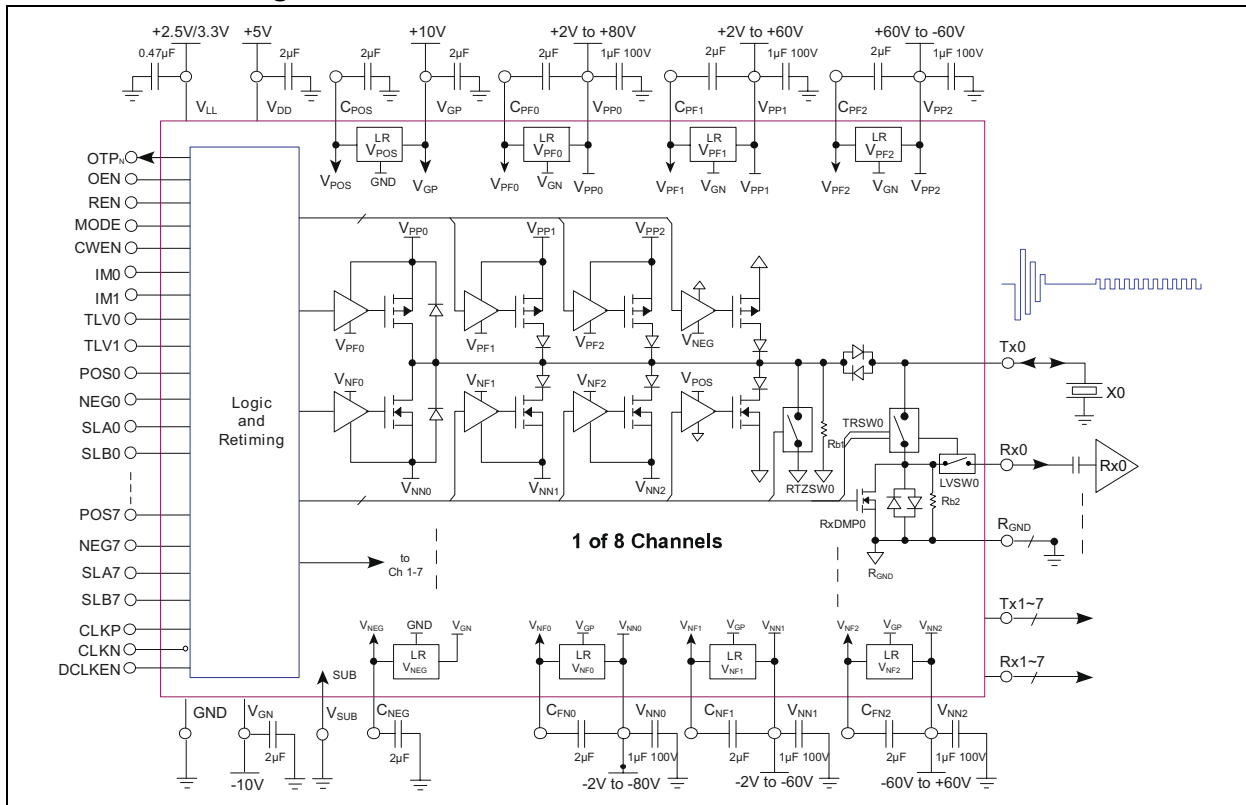
The integrated circuit (IC) has built-in gate-driver floating voltage regulators, allowing $V_{PP0,1,2}$ and $V_{NN0,1,2}$ high-voltage rails to move the voltage interdependently from 0 to $\pm 80V$ or to 60V. Each of the pulsers has output voltage overshoot clamping diodes to the highest level of the supply pin of V_{PP0} or V_{NN0} rails respectively. The differential clock inputs take Differential Clock or LVCMOS output signals. The logic control voltages are designed to work with the Differential Clock or the LVCMOS logic families directly.

HV7322

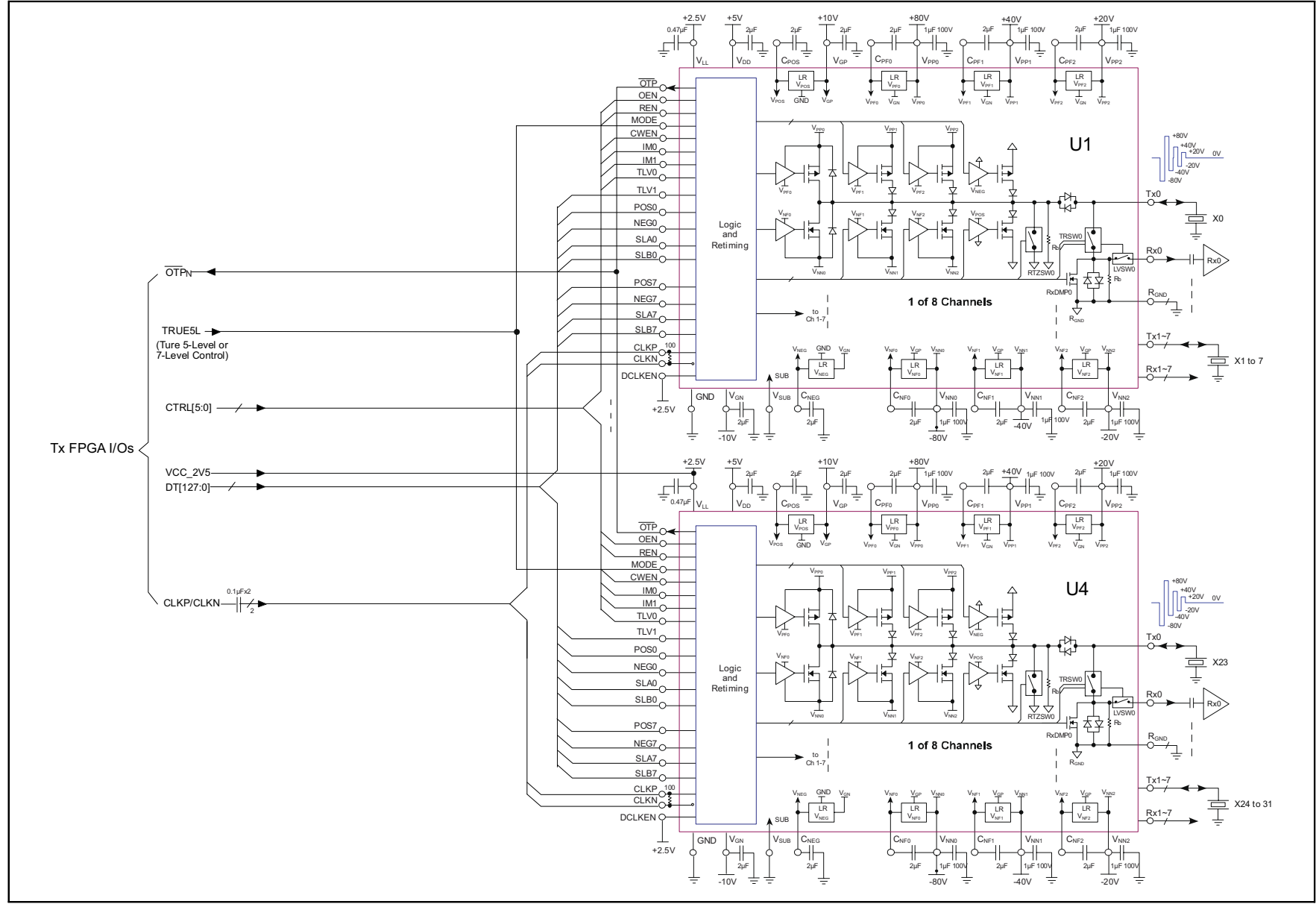
Package Types



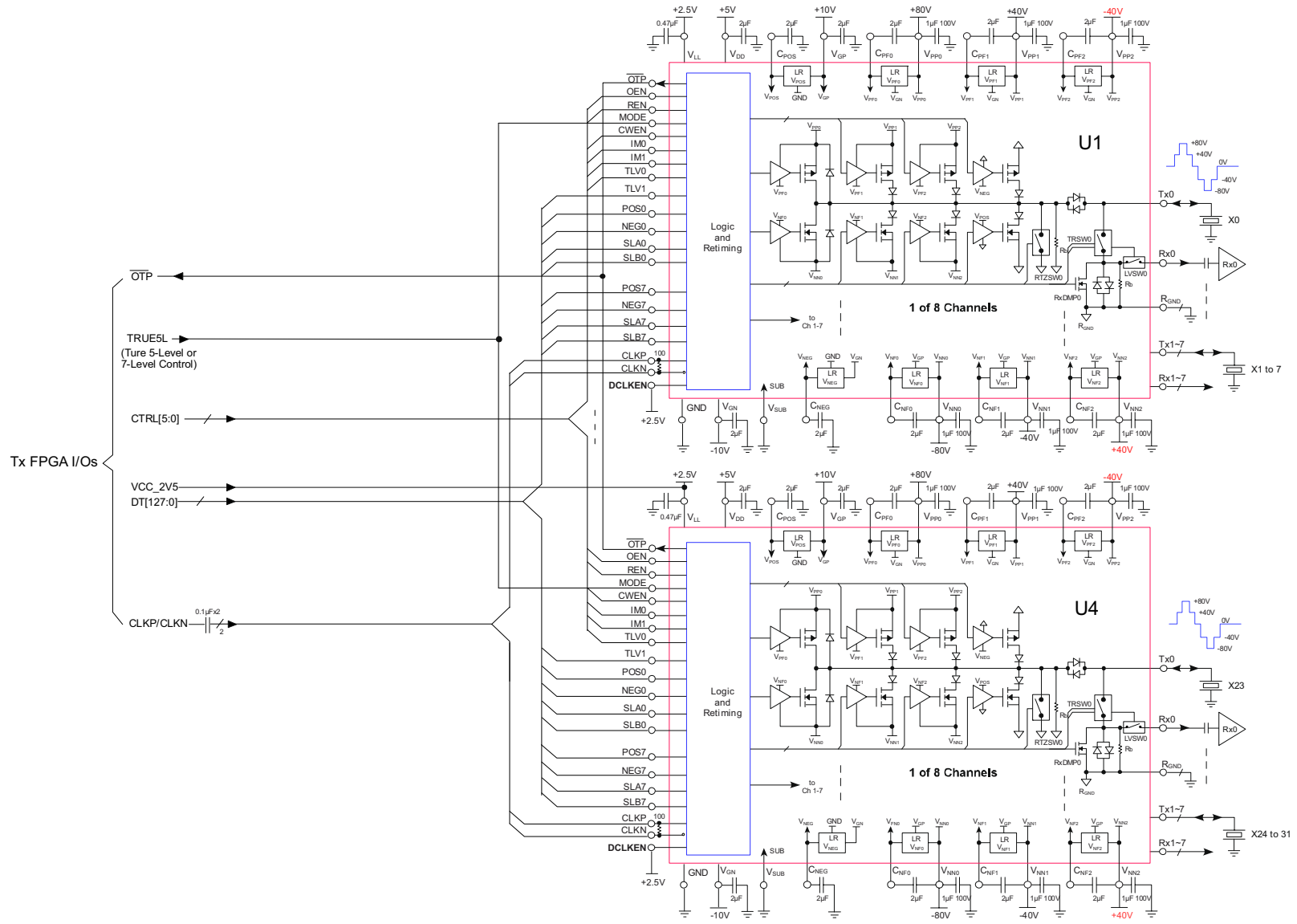
HV7322 - Block Diagram



HV7322 - Typical 7-Level Application Diagram



HV7322 - Typical True 5-Level Application Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Logic Voltage (V_{LL}).....	-0.5V to +5.5V
All I/O and CLK pin voltage (V_{IO}).....	-0.5V to +5.5V
Positive voltage supply (V_{DD}).....	-0.5V to +5.5V
Positive gate driver supply (V_{GP}).....	-0.5V to +13.5V
Negative gate driver supply (V_{GN}).....	-13.5V to +0.5V
High-voltage positive supply (V_{PP0}).....	-1.0V to +85V
High-voltage positive supply (V_{PP1}).....	-1.0V to +65V
High-voltage positive supply (V_{PP2}).....	-65V to +65V
High-voltage negative supply (V_{NN0}).....	-85V to +1.0V
High-voltage negative supply (V_{NN1}).....	-65V to +1.0V
High-voltage negative supply (V_{NN2}).....	-65V to +65V
TX pin voltage (V_{TX}).....	-85V to +85V
RX pin to GND voltage (V_{RX}).....	± 0.7 to ± 1.4 V
Maximum not-latch-up current (I_{LU}).....	+100 mA
ESD HBM Rating T_X , V_{PP} , V_{NN} , CPF, CNF, CNEG, CPOS, V_{GP} , V_{GN} , R_X , R_{GND} pins.....	-0.50 to +0.50 kV
ESD HBM Rating – all other LV pins.....	-2.0 to +2.0 kV

† **Notice:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

Electrical specifications: $V_{LL} = +2.5$ V, $V_{DD} = +5.0$ V, $V_{PP0} = +80$ V, $V_{NN0} = -80$ V, $V_{PP1,2} = +60$ V, $V_{NN1,2} = -60$ V, $V_{GP} = +10$ V, $V_{GN} = -10$ V, $V_{SUB} = 0$ V, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ$ C.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Operating Supply Voltages						
Positive Logic Supply	V_{LL}	2.25	2.50	3.60	V	—
Internal Voltage Supply	V_{DD}	4.75	5.0	5.25	V	—
Positive Gate Driver Supply	V_{GP}	8.0	10	12	V	—
Negative Gate Driver Supply	V_{GN}	-12	-10	-8.0	V	—
High Voltage Positive Supply	V_{PP0}	0	—	80	V	Must be $V_{PP0} \geq V_{PP1}$ and V_{PP2}
	V_{PP1}	0	—	60	V	Must be $V_{PP1} \leq V_{PP0}$
	V_{PP2}	0	—	60	V	$MODE = 0$ In the 7-Level Mode. Must be $V_{PP2} \leq V_{PP0}$
	V_{PP2}	$V_{NN1} - 0.7$	V_{NN1}	$V_{NN1} + 0.7$	V	$MODE = 1$ $ V_{PP2} - V_{NN1} \leq 0.7$

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
High Voltage Negative Supply	V_{NN0}	-80	—	0	V	Must be $V_{NN0} \leq V_{NN1}$ and V_{NN2}
	V_{NN1}	-60	—	0		Must be $V_{NN1} \geq V_{NN0}$
	V_{NN2}	-60	—	0	V	MODE = 0 In the 7-Level Mode. Must $V_{NN2} \geq V_{NN0}$
	V_{NN2}	$V_{PP1} - 0.7$	V_{PP1}	$V_{PP1} + 0.7$	V	MODE = 1 $ V_{NN2} - V_{PP1} \leq 0.7$
Operating Supply Current						
V_{LL} Quiescent Current	I_{LLQ}	—	2	5	μA	OEN = REN = 0
V_{DD} Quiescent Current	I_{DDQ}	—	54	65	μA	
V_{PP0} Quiescent Current	I_{PP0Q}	—	—	15	μA	
V_{NN0} Quiescent Current	I_{NN0Q}	-15	—	—	μA	
V_{PP1} Quiescent Current	I_{PP1Q}	—	—	20	μA	
V_{NN1} Quiescent Current	I_{NN1Q}	-20	—	—	μA	
V_{PP2} Quiescent Current	I_{PP2Q}	—	—	40	μA	
V_{NN2} Quiescent Current	I_{NN2Q}	-40	—	—	μA	
V_{DD} Current	I_{DDEN}	—	1	2	mA	DCLKEN = 0 $f_{TX} = 0$ MHz $f_{CLK} = 0$
V_{PP0} Current	I_{PP0EN}	—	0.26	0.4	mA	
V_{NN0} Current	I_{NN0EN}	-0.4	-0.34	—	mA	
V_{PP1} Current	I_{PP1EN}	—	0.12	0.3	mA	
V_{NN1} Current	I_{NN1EN}	-0.3	-0.13	—	mA	
V_{PP2} Current	I_{PP2EN}	—	0.12	0.3	mA	
V_{NN2} Current	I_{NN2EN}	-0.3	-0.12	—	mA	
V_{LL} Current with Re-Timing	I_{LL_DCLK}	—	0.41	0.45	mA	DCLKEN = 1, $f_{CLK} = 160$ MHz TX one-channel output active, no load. The continuous values are calculated from measured burst-mode 5 MHz cases.
V_{DD} Current with Re-Timing	I_{DD_DCLK}	—	25	30	mA	

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions	
V_{LL} Maximum Current in B-Mode	I_{LL5}	—	26	60	μA	DCLKEN = 0 $f_{CLK} = 0$ MHz, in B-Mode	
V_{DD} Maximum Current in B-Mode	I_{DD5}	—	1.4	1.6	mA	TX one-channel output, no loads.	
V_{GP} Maximum Current in B-Mode	I_{GP5}	—	3.4	6	mA	The continuous values are calculated from the measured burst-mode 5 MHz cases. I_{NN25} and I_{PP25} are only in 7-Level Mode.	
V_{GN} Maximum Current in B-Mode	I_{GN5}	-16	-12.9	—	mA		
V_{PP0} Current in B-Mode	I_{PP05}	—	102	115	mA		
V_{NN0} Current in B-Mode	I_{NN05}	-105	-96	—	mA		
V_{PP1} Current in B-Mode	I_{PP15}	—	85	95	mA		
V_{NN1} Current in B-Mode	I_{NN15}	-95	-84	—	mA		
V_{PP2} Current in B-Mode	I_{PP25}	—	94	105	mA		
V_{NN} Current in B-Mode	I_{NN25}	-100	-91	—	mA		
V_{GP} Current in CW-Mode	I_{GPCW}	—	1.5	2	mA		TX one-channel output 5 MHz, continuous, no loads. $V_{PP1}/V_{NN1} = \pm 5V$ in CW-Mode. SLB = 0, SLA = 1, Note 1
V_{GN} Current in CW-Mode	I_{GNCW}	-4.4	-4	—	mA		
V_{PP1} Current in CW-Mode	I_{PP1CW}	—	24.4	26	mA		
V_{NN1} Current in CW-Mode	I_{NN1CW}	-26	-23.5	—	mA		
TX Output P-Channel MOSFET on V_{PP0}, V_{PP2}							
On-Resistance	R_{ON_P0}	—	13	16	Ω	$I_{SD} = 100$ mA	
Peak Output Current	I_{OUT_P0}	0.9	1.1	—	A	$V_{PP0} = 25V$, $R_L = 1.0\Omega$ to GND, Note 1	
		1.7	2.02	—	A	$V_{PP0} = 80V$, $R_L = 1.0\Omega$ to GND, Note 1	
On-Resistance	R_{ON_P2}	—	12.1	14	Ω	$I_{SD} = 100$ mA	
Peak Output Current	I_{OUT_P2}	1.2	1.4	—	A	$V_{PP2} = 25V$, $R_L = 1.0\Omega$ to GND, Note 1	
		1.6	2.0	—	A	$V_{PP2} = 60V$, $R_L = 1.0\Omega$ to GND, Note 1	

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2: Design guidance only.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^{\circ}C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TX Output P-Channel MOSFET on V_{PP1}						
Peak Output Current $IM<1:0> = 00$	I_{OUT_P1} $CWEN = 0$	0.3	0.39	—	A	$V_{PP1} = 25V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle. $D\% = 0.1\%$, Note 1
Peak Output Current $IM<1:0> = 01$		0.6	0.76	—		
Peak Output Current $IM<1:0> = 10$		0.9	0.11	—		
Peak Output Current $IM<1:0> = 11$		1.2	1.44	—		
Peak Output Current $IM<1:0> = 00$		0.35	0.5	—		$V_{PP1} = 60V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle. $D\% = 0.1\%$, Note 1
Peak Output Current $IM<1:0> = 01$		0.8	1.0	—		
Peak Output Current $IM<1:0> = 10$		1.15	1.5	—		
Peak Output Current $IM<1:0> = 11$		1.6	1.9	—		
On-resistance $IM<1:0> = 11$	R_{ON_P1} $CWEN = 0$	—	11.2	13	—	$I_{SD} = 100$ mA, Note 1
Peak Output Current $IM<1:0> = 00$	I_{OUT_P1} $CWEN = 1$	160	192	—	mA	$V_{PP1} = 10V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle. $D\% = 0.1\%$, Note 1
Peak Output Current $IM<1:0> = 01$		320	362	—		
CW On-Resistance $IM<1:0> = X0$	R_{ON_P1} $CWEN = 1$	—	41.6	47	Ω	$I_{SD} = 100$ mA, Note 1
CW On-Resistance $IM<1:0> = X1$		—	20	22		
TX Output N-Channel MOSFET on V_{NN0}, V_{NN2}						
On-Resistance	R_{ON_N0}	—	10	12	Ω	$I_{DS} = 100$ mA
Peak Output Current	I_{OUT_N0}	—	-1.3	-1.1	A	$V_{NN0} = -25V$, $R_L = 1.0\Omega$ to GND, Note 1
		—	-1.8	-1.5	A	$V_{NN0} = -80V$, $R_L = 1.0\Omega$ to GND, Note 1
On-Resistance	R_{ON_N2}	—	8.6	10	Ω	$I_{DS} = 100$ mA
Peak Output Current	I_{OUT_N2}	—	-1.5	-1.3	A	$V_{NN2} = -25V$, $R_L = 1.0\Omega$ to GND, Note 1
		—	-1.92	-1.5	A	$V_{NN2} = -60V$, $R_L = 1.0\Omega$ to GND, Note 1

Note 1: Characterized only; not 100% tested in production.

Note 2: Design guidance only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TX Output N-Channel MOSFET on V_{NN1}						
Peak Output Current $IM<1:0> = 00$	I_{OUT_N1} $CWEN = 0$	—	-0.42	-0.3	A	$V_{NN1} = -25V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle D% = 0.1%, Note 1
Peak Output Current $IM<1:0> = 01$		—	-0.8	-0.6		
Peak Output Current $IM<1:0> = 10$		—	-1.16	-0.9		
Peak Output Current $IM<1:0> = 11$		—	-1.51	-1.3		
Peak Output Current $IM<1:0> = 00$		$V_{NN1} = -60V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle D% = 0.1%, Note 1	—	-0.5	-0.35	A
Peak Output Current $IM<1:0> = 01$			—	-1.0	-0.7	
Peak Output Current $IM<1:0> = 10$			—	-1.5	-1.25	
Peak Output Current $IM<1:0> = 11$			—	-1.9	-1.6	
On-Resistance $IM<1:0> = 11$	R_{ON_N1} $CWEN = 0$	—	8.3	10	Ω	$I_{DS} = 100$ mA, Note 1
Peak Output Current $IM<1:0> = X0$	I_{OUT_N1} $CWEN = 1$	—	-212	-180	mA	$V_{NN1} = -10V$, $R_L = 1.0\Omega$ to GND 20 ns pulse width at the duty cycle D% = 0.1%, Note 1
Peak Output Current $IM<1:0> = X1$		—	-386	-340		
CW On-Resistance $IM<1:0> = X0$	R_{ON_N1} $CWEN = 1$	—	42	48	Ω	$I_{DS} = 100$ mA, Note 1
CW On-Resistance $IM<1:0> = X1$		—	17	19		
TX Damping MOSFET on GND						
On-Resistance	R_{ON_PDMP}	—	9	14	Ω	$I_{SD} = 100$ mA, Note 1
B-Mode Peak Output Current ⁽¹⁾	I_{OUT_PDMP}	1.15	1.57	—	A	$R_L = 1.0\Omega$ at TX to $V_{NN0} = -25V$ 20 ns pulse width at D% = 0.1%, Note 1
		1.35	1.9	—	A	$R_L = 1.0\Omega$ at TX to $V_{NN0} = -80V$ 20 ns pulse width at D% = 0.1%, Note 1
On-Resistance	R_{ON_NDMP}	—	7	13	Ω	$I_{DS} = 100$ mA, Note 1
B-Mode Peak Output Current ⁽¹⁾	I_{OUT_NDMP}	—	-1.56	-1.15	A	$R_L = 1.0\Omega$ at TX to $V_{PP0} = +25V$ 20 ns pulse width at D% = 0.1%, Note 1
		—	-2.02	-1.6	A	$R_L = 1.0\Omega$ at TX to $V_{PP0} = +80V$ 20 ns pulse width at D% = 0.1%, Note 1

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2: Design guidance only.

HV7322

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
RTZSW Auto Bleed High-Voltage Analog Switch						
RTZSW On-Resistance	R_{RTZSW}	—	152	164	Ω	$I_{RTZSW} = \pm 1.0 \text{ mA}$, Note 1
RTZSW to GND Bleed Resistors	R_{b1}	18	20	22	$k\Omega$	Note 1
RTZSW Off Withstand Voltage	V_{RTZSW}	-80	—	+80	V	$I_{RTZSW} = \pm 100 \mu A$, Note 1
TX OUTPUT Isolation Diodes and Bleed Resistor						
Diode Forward Voltage	V_F	—	1.2	1.9	V	$I_{FM} = 300 \text{ mA}$, Note 2
Forward Continuous Current	I_{FM}	—	250	—	mA	Note 2
Peak Forward Pulse Current	I_{FSM}	—	3.0	—	A	$PW = 50 \text{ ns}$, Note 2
Total Capacitance of 2-Diode	C_T	—	3.2	4	pF	At 1 MHz, 1 dBm, 0V DC, Note 2
TRSW, LVSW and RXDMP Switches						
TRSW and LVSW Switch-On Resistor	R_{TRSW}	—	13	18	Ω	$I_{TRSW} = \pm 1.0 \text{ mA}$, Note 1
TRSW Off Withstand Voltage	V_{TRSW}	-80	—	+80	V	$I_{SW} = \pm 100 \mu A$, Note 1
LVSW Off Withstand Voltage	V_{LVSW}	-5.0	—	+5.0	V	$I_{SW} = \pm 10 \mu A$, Note 1
RX to GND Protection Diode	V_F	—	1	1.2	V	$I_F = \pm 20 \text{ mA}$, Note 1
RXDMP Switch On-Resistance	R_{RXDMP}	—	14	19	Ω	$I_{SD} = \pm 1.0 \text{ mA}$, Note 1
RX0~7 Pin to GND Bleed Resistor	R_{b2}	13	20	27	$k\Omega$	Note 2
RX Pin to GND Capacitance	C_{RXG}	—	20	22	pF	1 MHz, 1 dBm, 0V DC, Note 2
Built-In Gate Drive Voltage Linear Regulators						
Output P-Channel Gate Drive Voltage Referenced to V_{PP0}	V_{PF0}	-5.2	-4.5	-4.1	V	$V_{GN} - V_{PP0} < -10V$
Output P-Channel Gate Drive Voltage Referenced to V_{PP1}	V_{PF1}	-5.2	-4.5	-4.1	V	$V_{GN} - V_{PP1} < -10V$
Output P-Channel Gate Drive Voltage Referenced to V_{PP2}	V_{PF2}	-5.2	-4.5	-4.1	V	$V_{NN0} - V_{PP2} < -10V$
Output N-Channel Gate Drive Voltage Referenced to V_{NN0}	V_{NF0}	3.6	4.4	5.2	V	$V_{GP} - V_{NN0} > 10V$

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Output N-Channel Gate Drive Voltage Referenced to V_{NN1}	V_{NF1}	3.6	4.4	5.2	V	$V_{GP} - V_{NN1} > 10V$
Output N-Channel Gate Drive Voltage Referenced to V_{NN2}	V_{NF2}	3.6	4.3	5.2	V	$V_{PP0} - V_{NN2} > 10V$
Output N-Channel Gate Drive Voltage Referenced to GND	V_{POS}	3.1	3.6	5.2	V	—
Output P-Channel Gate Drive Voltage Referenced to GND	V_{NEG}	-5.2	-4.3	-3.6	V	—
Logic & Clock Input Characteristics						
Input Logic Low Voltage	V_{IL}	0	—	$0.2 V_{LL}$	V	—
Input Logic High Voltage	V_{IH}	$0.8 V_{LL}$	—	V_{LL}	V	—
Input Logic Low Current	I_{IL}	-1.0	—	—	μA	Note 1
Input Logic High Current	I_{IH}	—	—	1.0	μA	Note 1
Input Capacitance	C_{IN}	—	3.0	4.0	pF	Note 2
OEN Switching On Time	t_{OEN}	—	240	300	μs	50% OEN rise to TX ready, Note 2
OEN Switching Off Time		—	0.4	—	μs	50% OEN fall to TX all output FETs on HV rails are off, Note 1
MODE Switching On Time	t_{MODE}	—	2	2.4	μs	50% Mode edge to the TX logic ready. Not including V_{PP2}/V_{NN2} decoupling capacitors recharging time, Note 2
MODE Switching Off Time		—	2	2.4	μs	
Thermal protection OTP_N & 5UVLO						
OTP_N Output Maximum Pull-Up	V_{OH}	—	—	5.25	V	—
OTP_N Output Low Maximum Voltage	V_{OL}	—	0	0.1	V	at 100 μA
		—	0.1	0.4	V	at 4.0 mA
OTP_N Output High Current	I_{OFF}	—	0.3	10	μA	0 to 125°C, at 5.25V pull-up, Note 1
Thermal Shutdown Trip Point	T_{TRIP}	126	142	158	°C	$OTP_N = 0$ when thermal shutdown occurs, Note 1
Thermal Shutdown Hysteresis	T_{HYS}	—	48	—	°C	

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
V_{DD} UVLO OK Voltage	V_{DDUVON}	4.0	4.2	4.3	V	—
V_{DD} UVLO Trip Voltage	$V_{DDUVOFF}$	3.7	3.78	3.9		
V_{LL} UVLO OK Voltage	V_{LLUVON}	1.7	1.76	1.9		
V_{LL} UVLO Trip Voltage	$V_{LLUVOFF}$	1.5	1.62	1.7		
V_{POS} UVLO OK Voltage	$V_{POSUVON}$	$0.7 \times V_{POS}$	$0.8 \times V_{POS}$	$0.9 \times V_{POS}$	V	Note 1
V_{POS} UVLO Trip Voltage	$V_{POSUVOFF}$	$0.63 \times V_{POS}$	$0.73 \times V_{POS}$	$0.83 \times V_{POS}$		
V_{NEG} UVLO OK Voltage	V_{NEGUON}	$0.7 \times V_{NEG}$	$0.8 \times V_{NEG}$	$0.9 \times V_{NEG}$		
V_{NEG} UVLO Trip Voltage	$V_{NEGUVOFF}$	$0.63 \times V_{NEG}$	$0.73 \times V_{NEG}$	$0.83 \times V_{NEG}$		
V_{PF0} UVLO OK Voltage	$V_{PF0UVON}$	$0.7 \times V_{PF0}$	$0.8 \times V_{PF0}$	$0.9 \times V_{PF0}$	V	Note 1
V_{PF0} UVLO Trip Voltage	$V_{PF0UVOFF}$	$0.63 \times V_{PF0}$	$0.73 \times V_{PF0}$	$0.83 \times V_{PF0}$		
V_{NF0} UVLO OK Voltage	$V_{NF0UVON}$	$0.7 \times V_{NF0}$	$0.8 \times V_{NF0}$	$0.9 \times V_{NF0}$		
V_{NF0} UVLO Trip Voltage	$V_{NF0UVOFF}$	$0.63 \times V_{NF0}$	$0.73 \times V_{NF0}$	$0.83 \times V_{NF0}$		
V_{PF1} UVLO OK Voltage	$V_{PF1UVON}$	$0.7 \times V_{PF1}$	$0.8 \times V_{PF1}$	$0.9 \times V_{PF1}$	V	Note 1
V_{PF1} UVLO Trip Voltage	$V_{PF1UVOFF}$	$0.63 \times V_{PF1}$	$0.73 \times V_{PF1}$	$0.83 \times V_{PF1}$		
V_{NF1} UVLO OK Voltage	$V_{NF1UVON}$	$0.7 \times V_{NF1}$	$0.8 \times V_{NF1}$	$0.9 \times V_{NF1}$		
V_{NF1} UVLO Trip Voltage	$V_{NF1UVOFF}$	$0.63 \times V_{NF1}$	$0.73 \times V_{NF1}$	$0.83 \times V_{NF1}$		
V_{PF2} UVLO OK Voltage	$V_{PF2UVON}$	$0.7 \times V_{PF2}$	$0.8 \times V_{PF2}$	$0.9 \times V_{PF2}$	V	Note 1
V_{PF2} UVLO Trip Voltage	$V_{PF2UVOFF}$	$0.63 \times V_{PF2}$	$0.73 \times V_{PF2}$	$0.83 \times V_{PF2}$		
V_{NF2} UVLO OK Voltage	$V_{NF2UVON}$	$0.7 \times V_{NF2}$	$0.8 \times V_{NF2}$	$0.9 \times V_{NF2}$		
V_{NF2} UVLO Trip Voltage	$V_{NF2UVOFF}$	$0.63 \times V_{NF2}$	$0.73 \times V_{NF2}$	$0.83 \times V_{NF2}$		

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^{\circ}C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TX Output & Switch Timing Characteristics						
Second Harmonic Distortion	HD2	—	-40	—	dB	HD2, test conditions: 2-waveform of 0° and 180° single-cycle 5.0 MHz, $V_{PP0}/V_{NN0} = \pm 60V$ launched in 100 μs apart, with load of 220 pF//1 k Ω . All these tr, tf and td values are also at $V_{PP0}/V_{NN0} = \pm 60V$, 220 pF//1 k Ω , Note 1
Output Rise Time from 0V to V_{PP0}	t_{r1}	—	14	16.5	ns	
Output Fall Time from 0V to V_{NN0}	t_{f1}	—	13	16.5		
Output Rise Time from V_{NN0} to V_{PP0}	t_{r2}	—	18	21		
Output Fall Time from V_{PP0} to V_{NN0}	t_{f2}	—	18	21		
Output Rise Time from V_{NN0} to 0V	t_{r3}	—	13.5	17		
Output Fall Time from V_{PP0} to 0V	t_{f3}	—	13.5	17		
Propagation Delay Rise Time 1	t_{dr1}	—	18	21	ns	
Propagation Delay Fall Time 1	t_{df1}	—	18	21		
Propagation Delay Rise Time 2	t_{dr2}	—	19	21.5		
Propagation Delay Fall Time 2	t_{df2}	—	19	21.5		
Propagation Delay Rise Time 3	t_{dr3}	—	18	21		
Propagation Delay Fall Time 3	t_{df3}	—	18	21		

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Output Rise Time from 0V to V_{PP1}	t_{r4}	—	10.5	13	ns	All the tr, tf, td values, at $V_{PP1}/V_{NN1} = \pm 60V$, 220 pF//1k Ω Note 1
Output Fall Time from 0V to V_{NN1}	t_{f4}	—	9.5	13		
Output Rise Time from V_{NN1} to V_{PP1}	t_{r5}	—	16	20		
Output Fall Time from V_{PP1} to V_{NN1}	t_{f5}	—	15.5	20		
Output Rise Time from V_{NN1} to 0V	t_{r6}	—	10.5	15		
Output Fall Time from V_{PP1} to 0V	t_{f6}	—	11	15		
Propagation Delay Rise Time 4	t_{dr4}	—	19	21	ns	
Propagation Delay Fall Time 4	t_{df4}	—	18.5	21		
Propagation Delay Rise Time 5	t_{dr5}	—	19.5	21.5		
Propagation Delay Fall Time 5	t_{df5}	—	19.5	21.5		
Propagation Delay Rise Time 6	t_{dr6}	—	18.5	21		
Propagation Delay Fall Time 6	t_{df6}	—	18.5	21		

- Note 1:** Characterized only; not 100% tested in production.
2: Design guidance only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^{\circ}C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Output Rise Time from 0V to V_{PP2}	t_{r7}	—	11	13.5	ns	All the t_r , t_f , t_d values, at $V_{PP2}/V_{NN2} = \pm 60V$, 220 pF//1k Ω Note 1
Output Fall Time from 0V to V_{NN2}	t_{f7}	—	10	13.5		
Output Rise Time from V_{NN2} to V_{PP2}	t_{r8}	—	16	21		
Output Fall Time from V_{PP2} to V_{NN2}	t_{f8}	—	16	21		
Output Rise Time from V_{NN2} to 0V	t_{r9}	—	10.5	15		
Output Fall Time from V_{PP2} to 0V	t_{f9}	—	11	15		
Propagation Delay Rise Time 7	t_{dr7}	—	19	21.5	ns	
Propagation Delay Fall Time 7	t_{df7}	—	18.5	21.5		
Propagation Delay Rise Time 8	t_{dr8}	—	19.5	22		
Propagation Delay Fall Time 8	t_{df8}	—	19.5	22		
Propagation Delay Rise Time 9	t_{dr9}	—	18.5	20.5		
Propagation Delay Fall Time 9	t_{df9}	—	18.5	20.5		
Delay Time Matching with SLB = 0, SLA = 0	Δt_{d1}	—	0.5	2.5	ns	P to N, channel-to-channel matching in IC, Note 1
Delay Time Matching with SLB = 0, SLA = 1	Δt_{d2}	—	0.5	2.5	ns	
Delay Time Matching with SLB = 1, SLA = 0	Δt_{d3}	—	0.5	2.5	ns	

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.						
Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
RTZSW Switch On Delay Time	t_{RTZSW}	95	106	120	ns	Note 1
RTZSW Switch Off Delay Time		95	108	120	ns	
RX Damp Switch On Delay Time	t_{RXDMP}	6	17	28	ns	
RX Damp Switch Off Delay Time		80	91	100	ns	
TRSW and LVSW Switch Off Delay Time	t_{LVSW}	135	160	185	ns	
TRSW and LVSW Switch On Delay Time TLV<1:0> = 00		485	515	545	ns	
TRSW and LVSW Switch On Delay Time TLV<1:0> = 01		560	597	635	ns	
TRSW and LVSW Switch On Delay Time TLV<1:0> = 10		635	680	735	ns	
TRSW and LVSW Switch On Delay Time TLV<1:0> = 11		715	763	815	ns	
Output Maximum Frequency Range	f_{OUT}	—	20	28	MHz	100 Ω resistor load, Note 1
Clock Time Low	t_{CLK_LO}	2.0	—	100	ns	CLK input must have at least one pulse POS and NEG inputs are not zero. Inputs must be returned to zero before stopping the clock, Note 2
Clock Time High	t_{CLK_HI}	2.0	—	100		
Clock Recognition Time	t_{CLK_REC}	2.0	—	—		
Clock Release Time	t_{CLK_RLS}	200	430	600		
LVC MOS25 Single-Ended Clock Input, DCLKEN = 0						
Clock Input Frequency Range	F_{CLK}	10	160	180	MHz	Note 1
Logic Input High Voltage	V_{IH}	$0.8 V_{LL}$	—	V_{LL}	V	—
Logic Input Low Voltage	V_{IL}	0	—	$0.2 V_{LL}$	V	—
Clock Input Rise/fall Time	t_{rf}	—	0.5	5.0	ns	Note 2
Set-up Time POS/NEG to CLK	t_{su}	2.0	—	—	ns	Note 2
Hold Time CLK to POS/NEG	t_H	1.0	—	—	ns	Note 2
Differential Clock Input, DCLKEN = 1, with Differential Clock driver's $V_{CC} = 1.8V$						

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

ELECTRICAL CHARACTERISTICS (CONTINUED)

Electrical specifications: $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $MODE = 0$, $OEN = REN = 1$, $T_A = 25^\circ C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
Clock Input Frequency Range	F_{CLK}	10	200	220	MHz	Note 1
Differential Sensitivity	V_{SNS}	300	400	—	mVp-p	at 160 MHz, Note 2
AC Common-Mode Voltage	V_{CMAC}	—	1.25	—	V	AC coupled, Note 2
DC Common-Mode Voltage	V_{CMDC}	1.0	—	1.4	V	DC coupled, Note 2
CLK Input Offset Voltage	V_{OFFSET}	—	37	—	mV	Note 2
CLK Input Differential Resistance	R_{IN_CLK}	—	21	—	k Ω	Note 2
CLK Input Common Resistance		—	4.8	—	k Ω	Note 2
CLK Input Capacitance	C_{IN_CLK}	—	4.0	—	pF	Note 2
TRSW & RXDMP Switching Spike Voltages						
TRSW Turn On Spike Voltage at TX Pins	V_{TRSW_ON}	—	130	150	mVp-p	TX _(ch) 50 Ω load to GND, Note 2
TRSW Turn Off Spike Voltage at TX Pins	V_{TRSW_OFF}	—	130	150		
RXDMP Turn On Spike Voltage at RX Pins	V_{RXDMP_ON}	—	130	150		RX _(ch) 300 Ω load to GND, Note 2
RXDMP Turn Off Spike Voltage at RX Pins	V_{RXDMP_OFF}	—	130	150		

Note 1: Characterized only; not 100% tested in production.

2: Design guidance only.

TEMPERATURE CHARACTERISTICS

Unless otherwise indicated, all parameters apply with $V_{LL} = +2.5V$, $V_{DD} = +5.0V$, $V_{PP0} = +80V$, $V_{NN0} = -80V$, $V_{PP1,2} = +60V$, $V_{NN1,2} = -60V$, $V_{GP} = +10V$, $V_{GN} = -10V$, $V_{SUB} = 0V$, $OEN = REN = 1$

Parameters	Sym.	Min.	Typ.	Max.	Units	Conditions
Temperature Ranges						
Operating Ambient Temperature Range	T_A	0	—	85	$^\circ C$	—
Storage Temperature Range	T_S	-55	—	150	$^\circ C$	—
Maximum Junction Temperature	T_J	—	—	130	$^\circ C$	—
Thermal Package Resistances (206L 12 mm x 12 mm TFBGA)						
Junction-to-Ambient Thermal Resistance	θ_{JA}	—	16	—	$^\circ C/W$	—
Junction-to-Board Thermal Resistance	θ_{JB}	—	3.5	—	$^\circ C/W$	—
Junction-to-Case Top Thermal Resistance	θ_{JC}	—	2.0	—	$^\circ C/W$	—

TABLE 1-1: INPUT OUTPUT LOGIC TRUTH TABLE

Function	OTP _N	Logic Inputs (No-Re-timing)							Tx Output	RTZSW & TRSW	LVSW	RXDMP
		OEN	MODE	CWEN	SLB	SLA	NEG	POS				
7-Level Mode ⁽¹⁾	1	1	0	0	0	0	0	0	RTZ	OFF	OFF	ON
	1	1	0	0	0	0	0	1	V _{PP0}	OFF	OFF	ON
	1	1	0	0	0	0	1	0	V _{NN0}	OFF	OFF	ON
	1	1	0	0	0	0	1	1	RTZ+	ON	ON	OFF
	1	1	0	0	0	1	0	0	RTZ	OFF	OFF	ON
	1	1	0	0	0	1	0	1	V _{PP1}	OFF	OFF	ON
	1	1	0	0	0	1	1	0	V _{NN1}	OFF	OFF	ON
	1	1	0	0	0	1	1	1	Hi-Z	OFF	OFF	ON
	1	1	0	0	1	0	0	0	RTZ	OFF	OFF	ON
	1	1	0	0	1	0	0	1	V _{PP2}	OFF	OFF	ON
	1	1	0	0	1	0	1	0	V _{NN2}	OFF	OFF	ON
	1	1	0	0	1	0	1	1	RTZ+	ON	ON	OFF
	1	1	0	0	1	1	0	0	RTZ	OFF	OFF	ON
	1	1	0	0	1	1	0	1	V _{PP2}	OFF	OFF	ON
	1	1	0	0	1	1	1	0	V _{NN2}	OFF	OFF	ON
True 5-Level Mode ⁽¹⁾	1	1	1	0	0	0	0	0	RTZ	OFF	OFF	ON
	1	1	1	0	0	0	0	1	V _{PP0}	OFF	OFF	ON
	1	1	1	0	0	0	1	0	V _{NN0}	OFF	OFF	ON
	1	1	1	0	0	0	1	1	RTZ+	ON	ON	OFF
	1	1	1	0	0	1	0	0	RTZ	OFF	OFF	ON
	1	1	1	0	0	1	0	1	V _{PP1}	OFF	OFF	ON
	1	1	1	0	0	1	1	0	V _{NN1}	OFF	OFF	ON
	1	1	1	0	0	1	1	1	Hi-Z	OFF	OFF	ON
	1	1	1	0	1	0	0	0	Hi-Z	OFF	OFF	ON
	1	1	1	0	1	0	1	0				
	1	1	1	0	1	0	1	1				
	1	1	1	0	1	1	0	0				
	1	1	1	0	1	1	1	1				
	1	1	1	0	1	1	1	0				
1	1	1	0	1	1	1	1					
Not Recommended	1	1	x	1	0	0	0	0	RTZ	OFF	OFF	ON
	1	1	x	1	0	0	0	1	V _{PP0}	OFF	OFF	ON
	1	1	x	1	0	0	1	0	V _{NN0}	OFF	OFF	ON
	1	1	x	1	0	0	1	1	RTZ+	ON	ON	OFF

- Note 1:** In B-Mode, the low-duty cycle must be used, due to the IC power dissipation limit.
- Note 2:** In CW-Mode, the MOSFET transistors of V_{PP1}/V_{NN1} voltage must be ≤±8V. Nothing other than SLB = 0 and SLA = 1 logic input status listed in above table should be used, due to the power dissipation limit.
- Note 3:** When the TX output is in RTZ+ state, the channel is in receiving mode (RTZ+).
- Note 4:** When the TX output is in Hi-Z state, all output MOSFET transistors are OFF.
- Note 5:** In the Re-Timing mode, SLA, SLB, NEG and POS inputs are latched-in at CLKP rising edge. The single-ended clock or the CLKP and CLKN are crossing points if the re-timing clock inputs are in differential configuration.

TABLE 1-1: INPUT OUTPUT LOGIC TRUTH TABLE (CONTINUED)

Function	OTP _N	Logic Inputs (No-Re-timing)							Tx Output	RTZSW & TRSW	LVSW	RXDMP
		OEN	MODE	CWEN	SLB	SLA	NEG	POS				
CW-Mode ⁽²⁾	1	1	x	1	0	1	0	0	RTZ	OFF	OFF	ON
	1	1	x	1	0	1	0	1	V _{PP1}	OFF	OFF	ON
	1	1	x	1	0	1	1	0	V _{NN1}	OFF	OFF	ON
	1	1	x	1	0	1	1	1	Hi-Z	OFF	OFF	ON
Not Recommended	1	1	x	1	1	0	0	0	RTZ	OFF	OFF	ON
	1	1	x	1	1	0	0	1	V _{PP2}	OFF	OFF	ON
	1	1	x	1	1	0	1	0	V _{NN2}	OFF	OFF	ON
	1	1	x	1	1	0	1	1	RTZ+	ON	ON	OFF
	1	1	x	1	1	1	0	0	RTZ	OFF	OFF	ON
	1	1	x	1	1	1	0	1	V _{PP2}	OFF	OFF	ON
	1	1	x	1	1	1	1	0	V _{NN2}	OFF	OFF	ON
1	1	x	1	1	1	1	1	RTZ+	ON	ON	OFF	
Device Disabled	x	0	x	x	x	x	x	x	Hi-Z	OFF	OFF	ON
Thermal Protection Activated	0	x	x	x	x	x	x	x	Hi-Z	OFF	OFF	ON

- Note 1:** In B-Mode, the low-duty cycle must be used, due to the IC power dissipation limit.
- 2:** In CW-Mode, the MOSFET transistors of V_{PP1}/V_{NN1} voltage must be $\leq \pm 8V$. Nothing other than SLB = 0 and SLA = 1 logic input status listed in above table should be used, due to the power dissipation limit.
- 3:** When the TX output is in RTZ+ state, the channel is in receiving mode (RTZ+).
- 4:** When the TX output is in Hi-Z state, all output MOSFET transistors are OFF.
- 5:** In the Re-Timing mode, SLA, SLB, NEG and POS inputs are latched-in at CLKP rising edge. The single-ended clock or the CLKP and CLKN are crossing points if the re-timing clock inputs are in differential configuration.

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1.1 Typical Timing Diagrams

Figure 1-1 displays the logic inputs of the TX output timing-delay and the TX high-voltage pulses output slew-rates timing parameters of the HV7322 device.

Figure 1-2 displays the logic inputs of the RTZSW, TRSW and RXDMP switches timing-delay parameters of the HV7322 device.

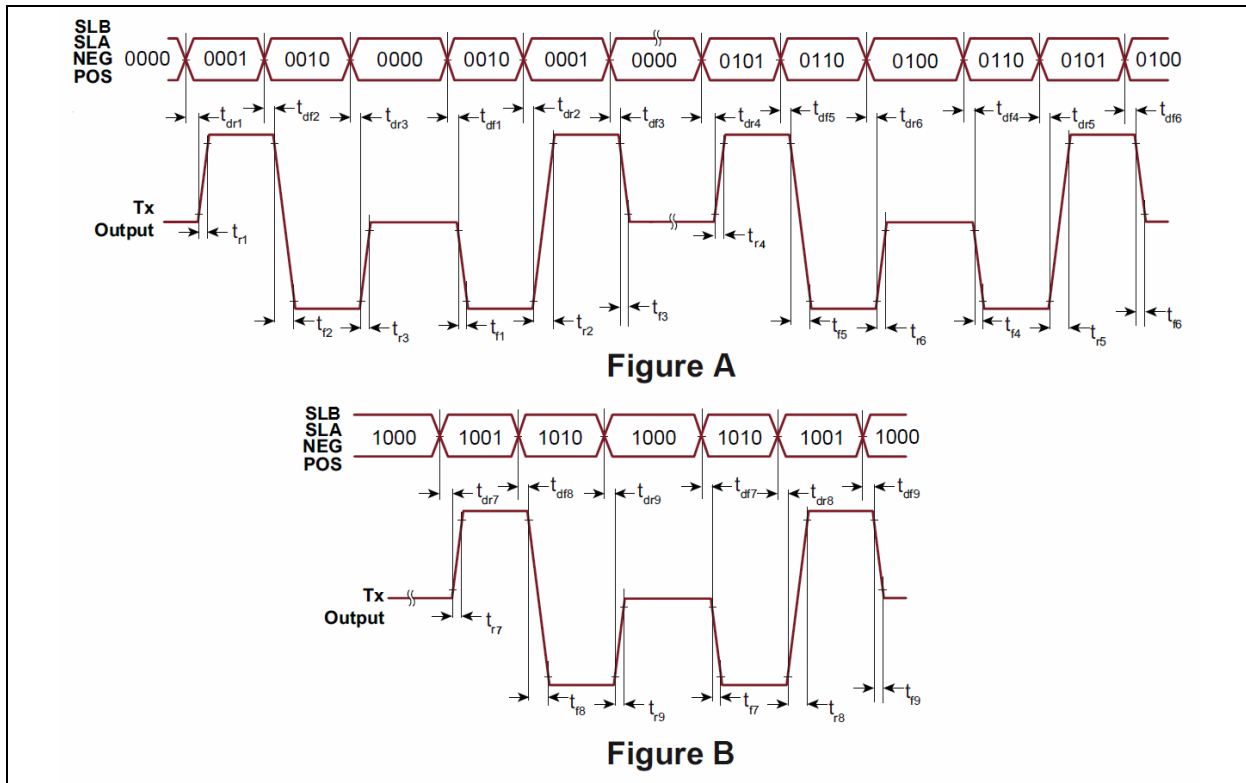


FIGURE 1-1: Logic Input and TX Output Timing Diagram.

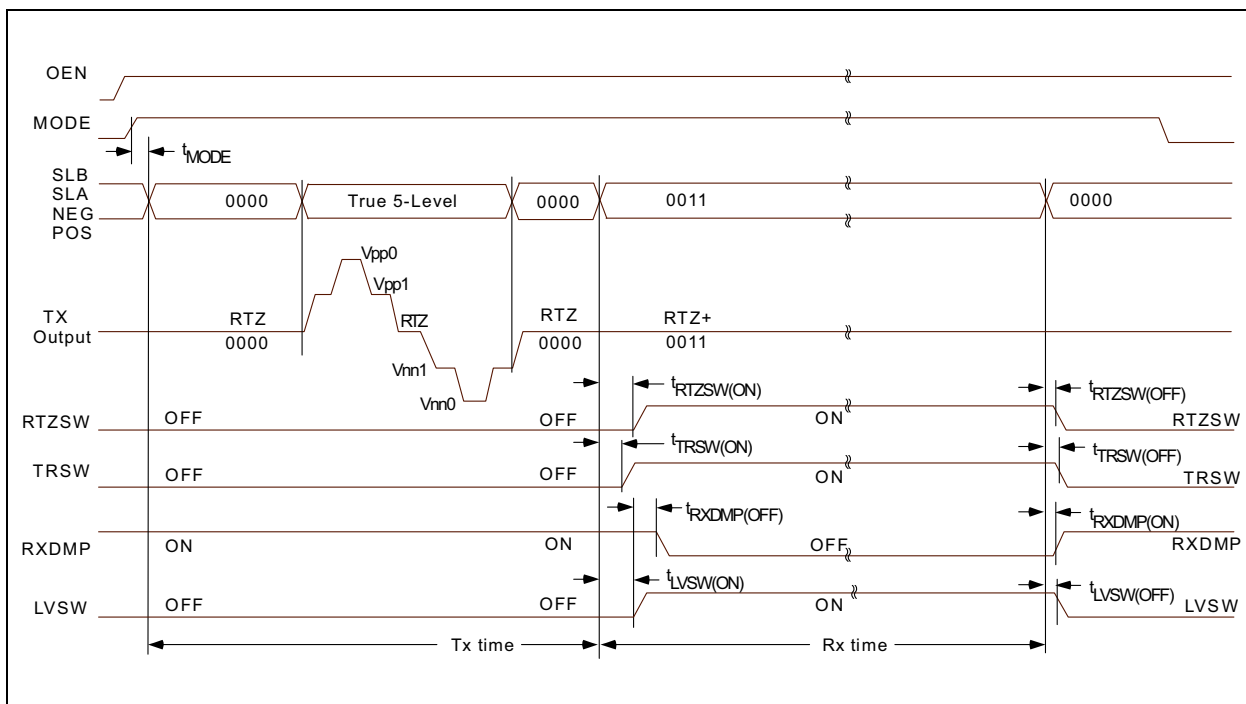


FIGURE 1-2: True 5-Level TX and Switches Timing Diagram (CWEN = 0).

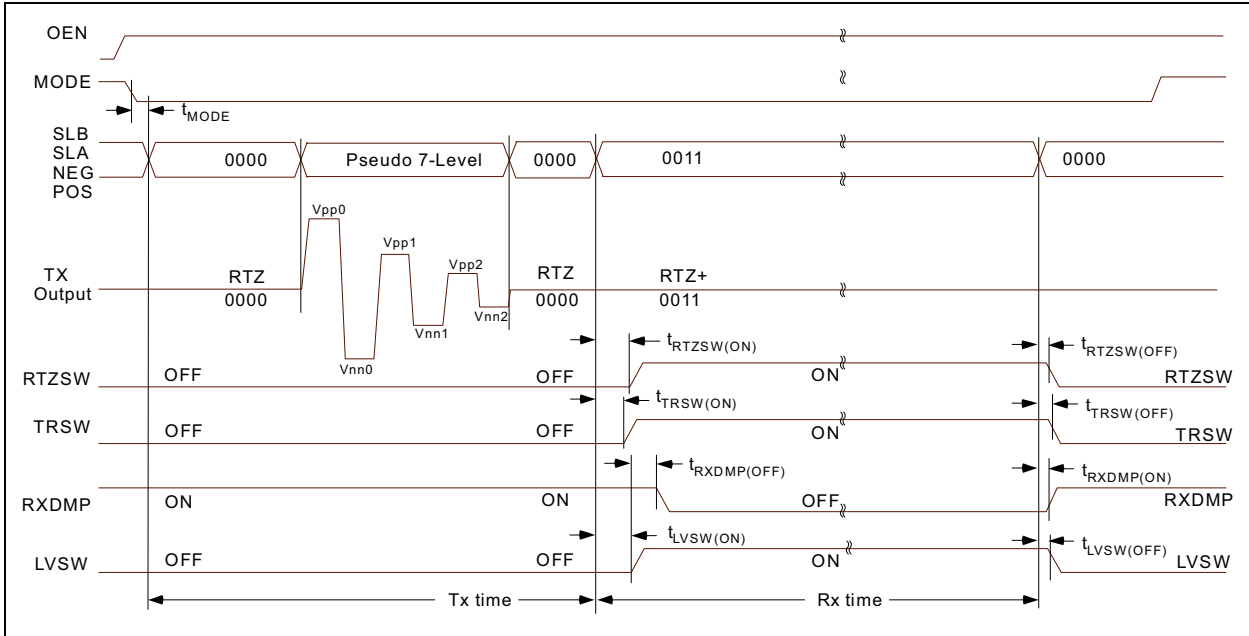


FIGURE 1-3: 7-Level TX and Switches Timing Diagram (CWEN = 0).

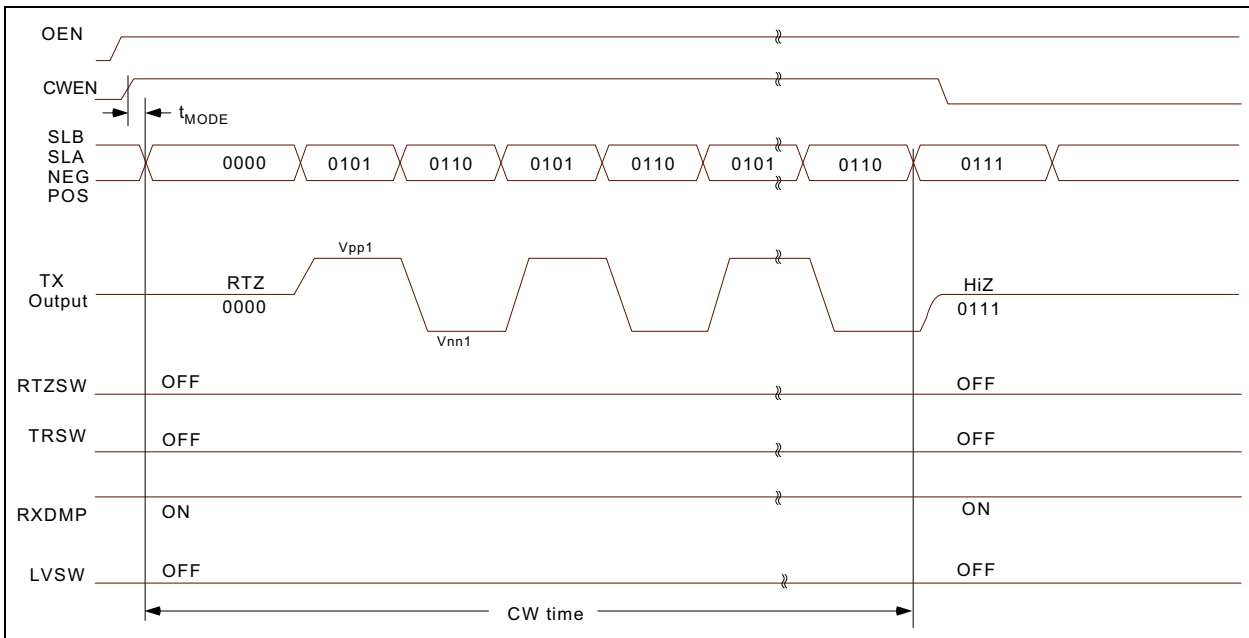


FIGURE 1-4: CW TX Waveform Timing Diagram (CWEN = 1).

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

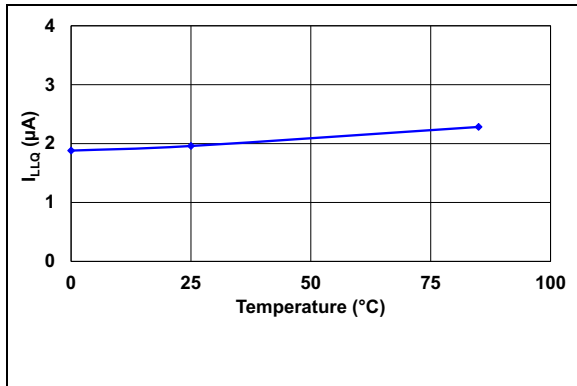


FIGURE 2-1: I_{LLQ} vs. Temperature.

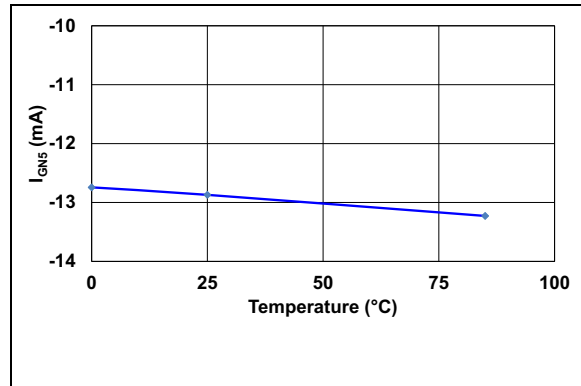


FIGURE 2-4: I_{GN5} vs. Temperature.

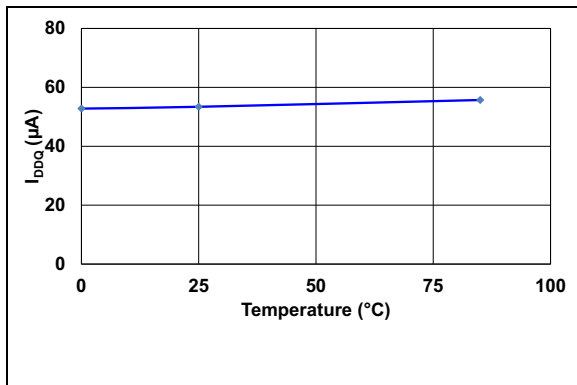


FIGURE 2-2: I_{DDQ} vs. Temperature.

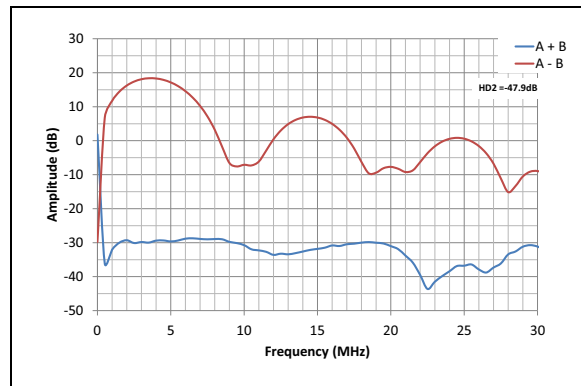


FIGURE 2-5: TX Output Pulse Cancellation FFT, using V_{NN0} and V_{PP0} , 1-Cycle 5 MHz with 220 pF/1 kΩ Load.

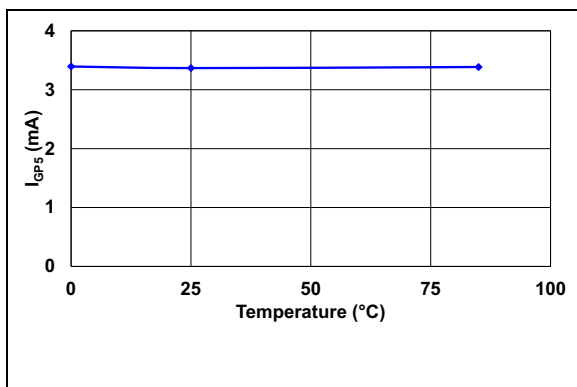


FIGURE 2-3: I_{GP5} vs. Temperature.

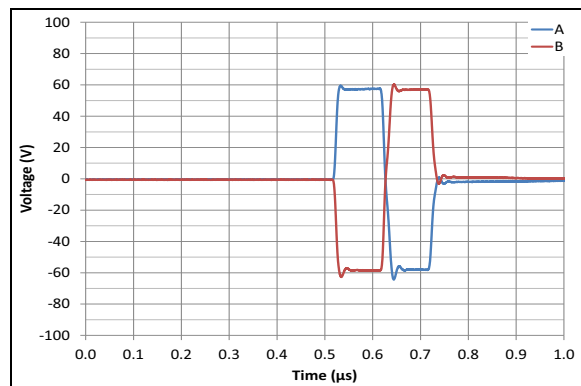


FIGURE 2-6: TX Output Pulse Cancellation, using V_{NN0} and V_{PP0} , 1-Cycle 5 MHz with 220 pF/1 kΩ Load.

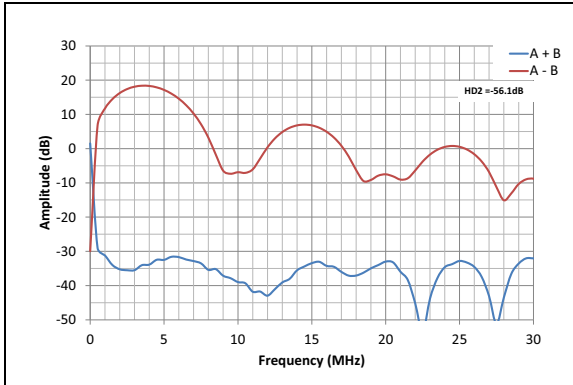


FIGURE 2-7: TX Output Pulse Cancellation FFT, using V_{NN1} and V_{PP1} , 1-Cycle 5 MHz with 220 pF//1 k Ω Load.

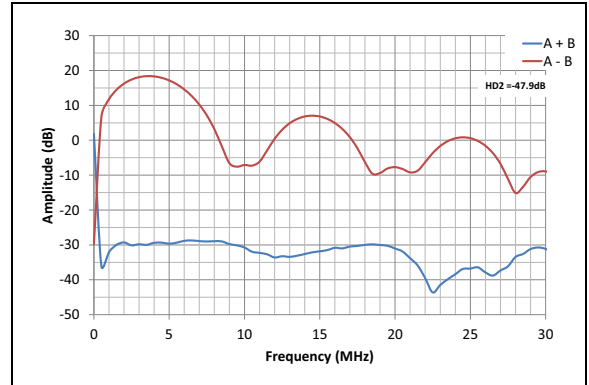


FIGURE 2-9: TX Output Pulse Cancellation FFT, using V_{NN2} and V_{PP2} , 1-Cycle 5 MHz with 220 pF//1 k Ω Load.

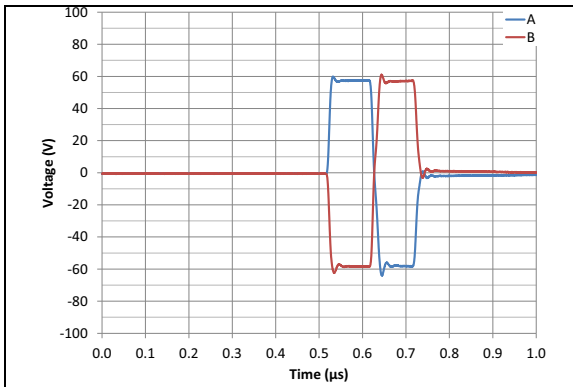


FIGURE 2-8: TX Output Pulse Cancellation, using V_{NN1} and V_{PP1} , 1-Cycle 5 MHz with 220 pF//1 k Ω Load.

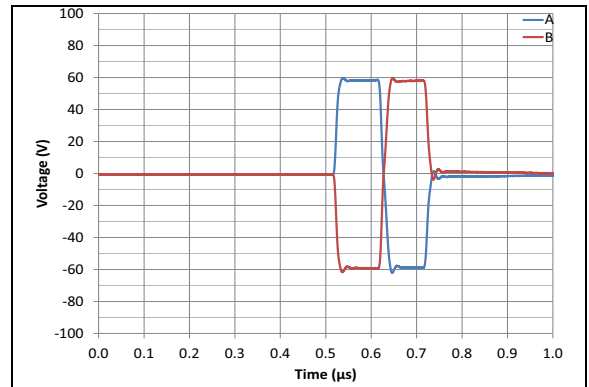


FIGURE 2-10: TX Output Pulse Cancellation, using V_{NN2} and V_{PP2} , 1-Cycle 5 MHz with 220 pF//1 k Ω Load.

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NOTES:

3.0 PIN DESCRIPTIONS

Table 3-1 lists the descriptions of the pins.

TABLE 3-1: PIN FUNCTION TABLE

Pin	Symbol	Description
A4, B2, D2, F2, N2, R2, U2, V4	SLA<0:7>	Selects V_{PP0}/V_{NN0} or V_{PP1}/V_{NN1} high-voltage rails. See Table 1-1.
A5, C2, E2, G2, M2, P2, T2, V5	SLB<0:7>	Selects V_{PP2}/V_{NN2} high-voltage rails. See Table 1-1.
A3, C1, E1, G1, M1, P1, T1, V3	NEG<0:7>	Turns ON and OFF the corresponding output N-channel MOSFET. See Table 1-1.
A2, B1, D1, F1, N1, R1, U1, V2	POS<0:7>	Turns ON and OFF the corresponding output P-channel MOSFET. See Table 1-1.
L1	DCLKEN	Logic input pin. When DCLKEN = 1, the CLKP/CLKN is set as Differential Clock type of inputs. When DCLKEN = 0, the CLKP/CLKN is set as LVCMOS single-ended clock input. Turning ON the Differential Clock function will result in the device consuming more power on V_{LL} .
H1	OEN	Output enable logic input pin. When OEN = V_{LL} , the transmitter outputs are enabled. When OEN = 0, the transmitter outputs are disabled.
U3, U4	IM<1:0>	Logic input pins for V_{PP1}/V_{NN1} output current, for all channels.
U5	CWEN	Logic input pins for TX mode control. CWEN = 0 B-Mode, CWEN = 1 CWD Mode.
B3, B4	TLV<1:0>	Logic input pins for $t_{LVS\text{W(ON)}}$ delay time selecting, for all channels.
J1, K1	CLKP CLKN	Differential/LVCMOS input clock. The inputs POS, NEG, SLA and SLB are aligned to the rising edge of the CLKP input clock signal. When the CLKP input is driven by LVCMOS, CLKN = DCLKEN = 0 permanently. When CLKP = CLKN = 0, the synchronization function is set to OFF and the internal retiming registers is bypassed. When DCLKEN = 1, CLKP/CLKN is internally self-biased and is be driven differentially through AC couples. An 100 Ω Differential line termination resistor needs to be connected between the two pins.
A1, E5, F5, G5, H4, H5, J4, J5, K4, K5, L5, M5, N5, P5, V1	GND	Ground, 0V, input logic reference is low and the return ground of V_{LL} and V_{DD} .
J2	V_{LL}	Input logic power supply pin.
H2	REN	Enable pin for the built-in voltage regulators. When REN = V_{LL} , all the regulators are ON. When REN = 0, all the regulator are OFF.
B5	OTP _N	Temperature sensor open drain output. When OTP _N = 0, the over temperature is detected. When the over temperature is detected, all outputs are in Hi-Z state, regardless of the input logic control.
A6, V6	V_{DD}	Level translator supply voltage, +5V, bypass capacitor, 2 μ F, 10V to GND per pin.
B6	V_{GN}	-10V supply pin for the linear regulator.
U6	V_{GP}	+10V supply pin for the linear regulator.
A13, B13, E12, F12, J12, K12, N12, P12, U13, V13	V_{PP0}	Positive high-voltage supply pin. V_{PP0} must be equal to or more positive than V_{PP1} or V_{PP2} .